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Application Information

Title Line One:: Thin Film Patterning Substrate And
Title Line Two:: Surface Treatment Therefor
Title Line Three::
Title Line Four::

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Continuity Information

>This application is a:: U.S. National Stage of
Application One:: PCT/JP99/01327
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Prior Foreign Applications

Foreign Application One:: 10-67508
Filing Date:: March 17, 1998
Country:: Japan
Priority Claimed:: yes
Foreign Application Two:: 11-32123
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